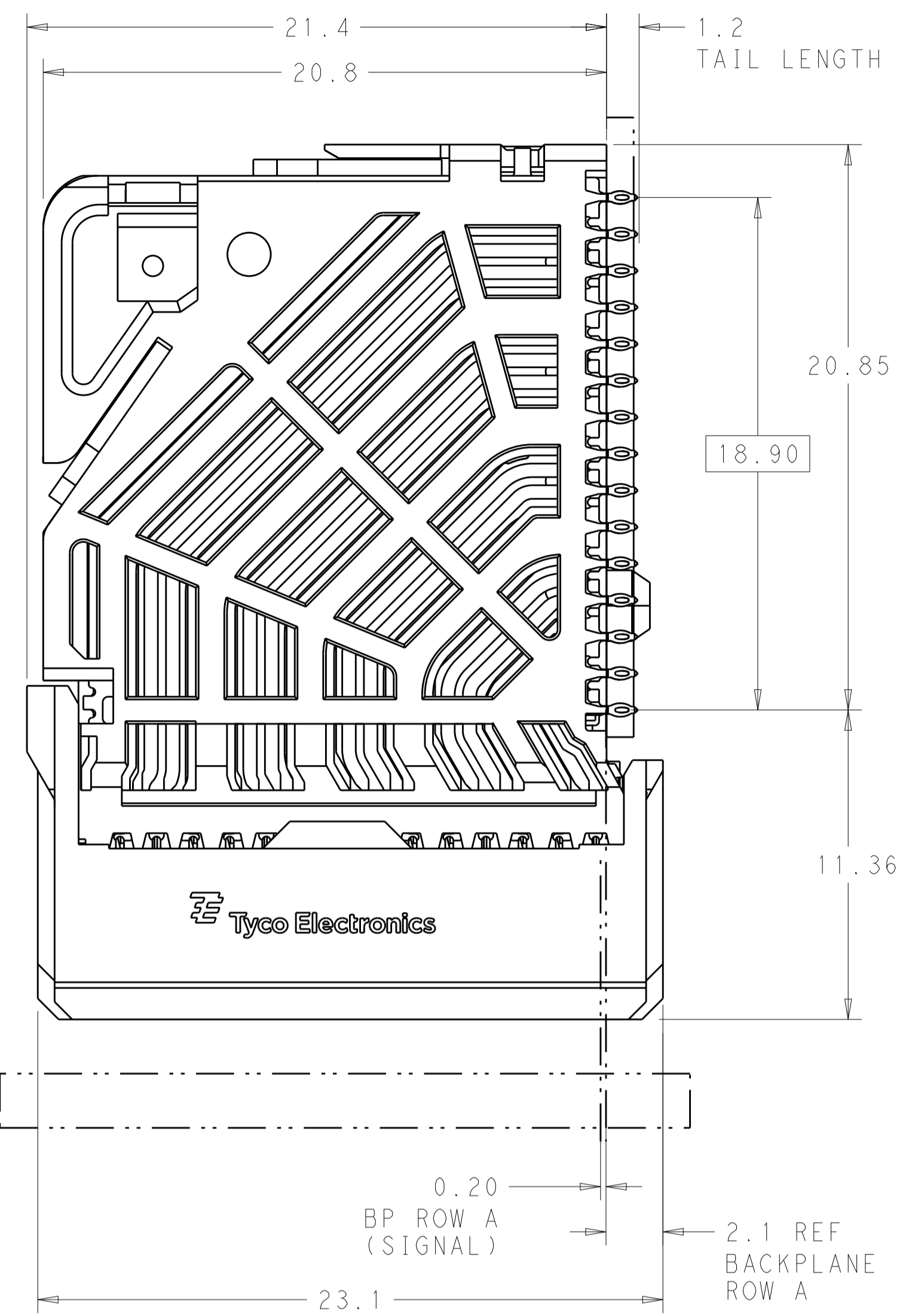
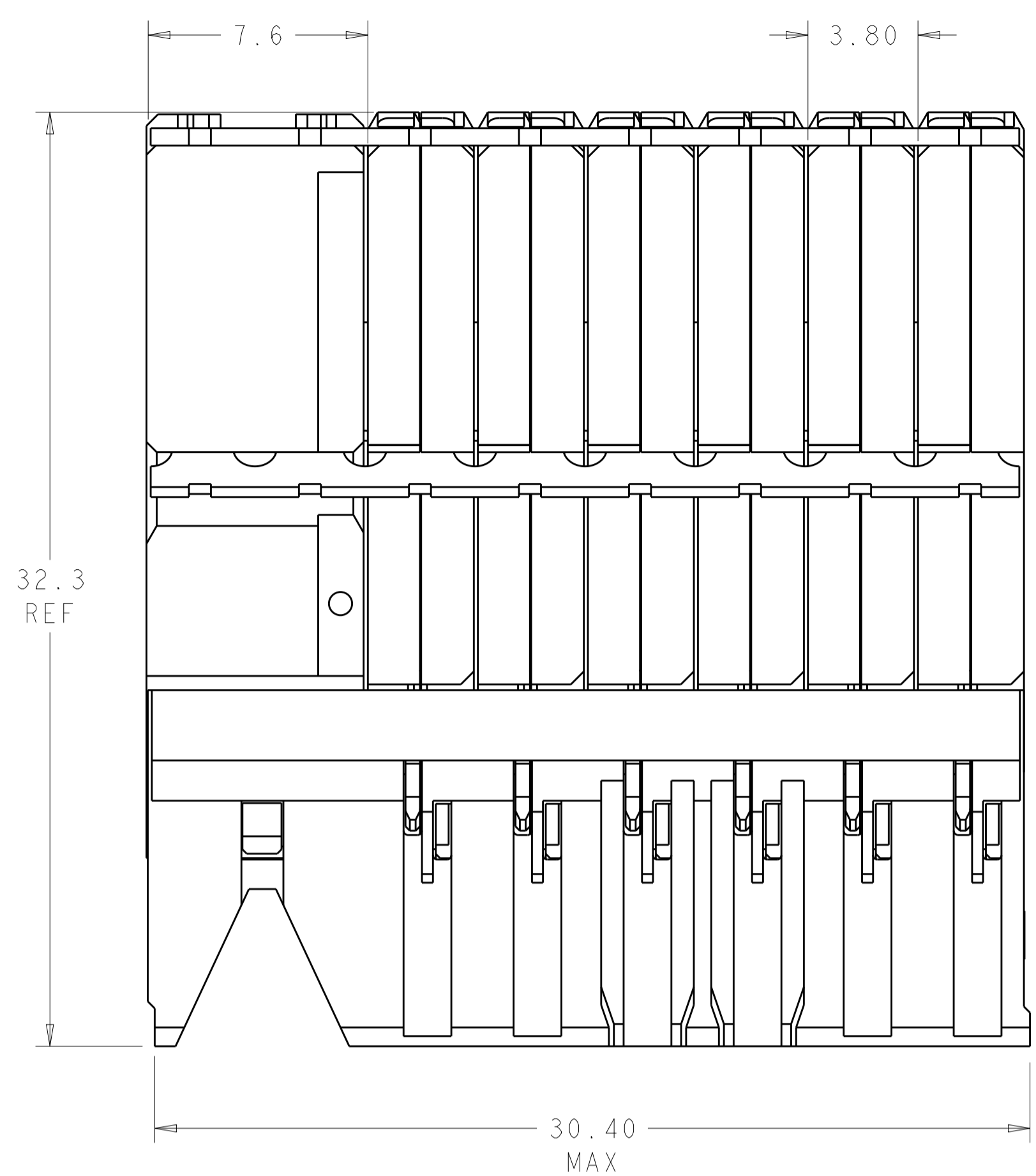
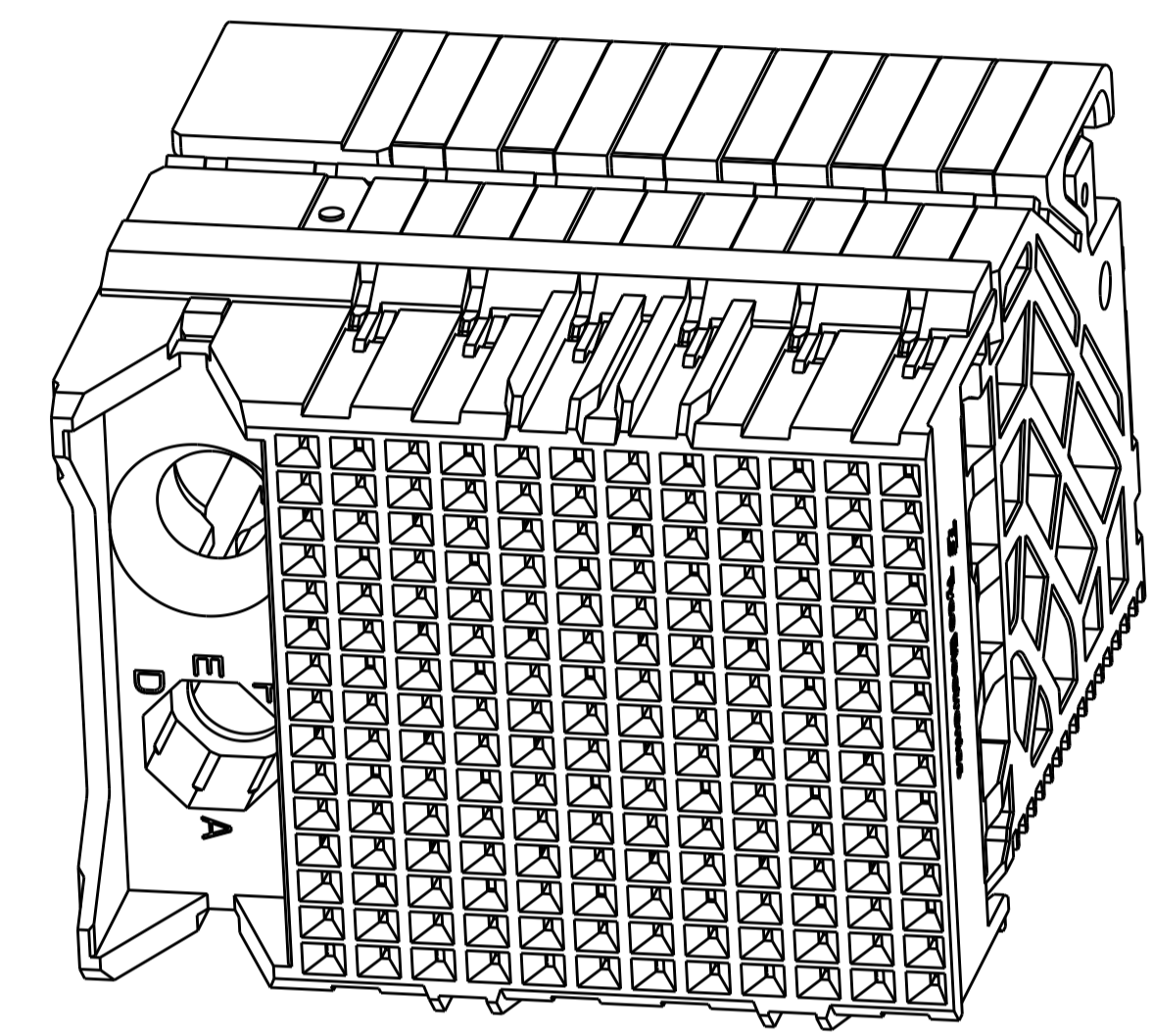


REVISIONS				
P.	LTN	DESCRIPTION	DATE	OWN APVD
B2		REVISED PER ECO-15-004915	09APR2015	AP DD

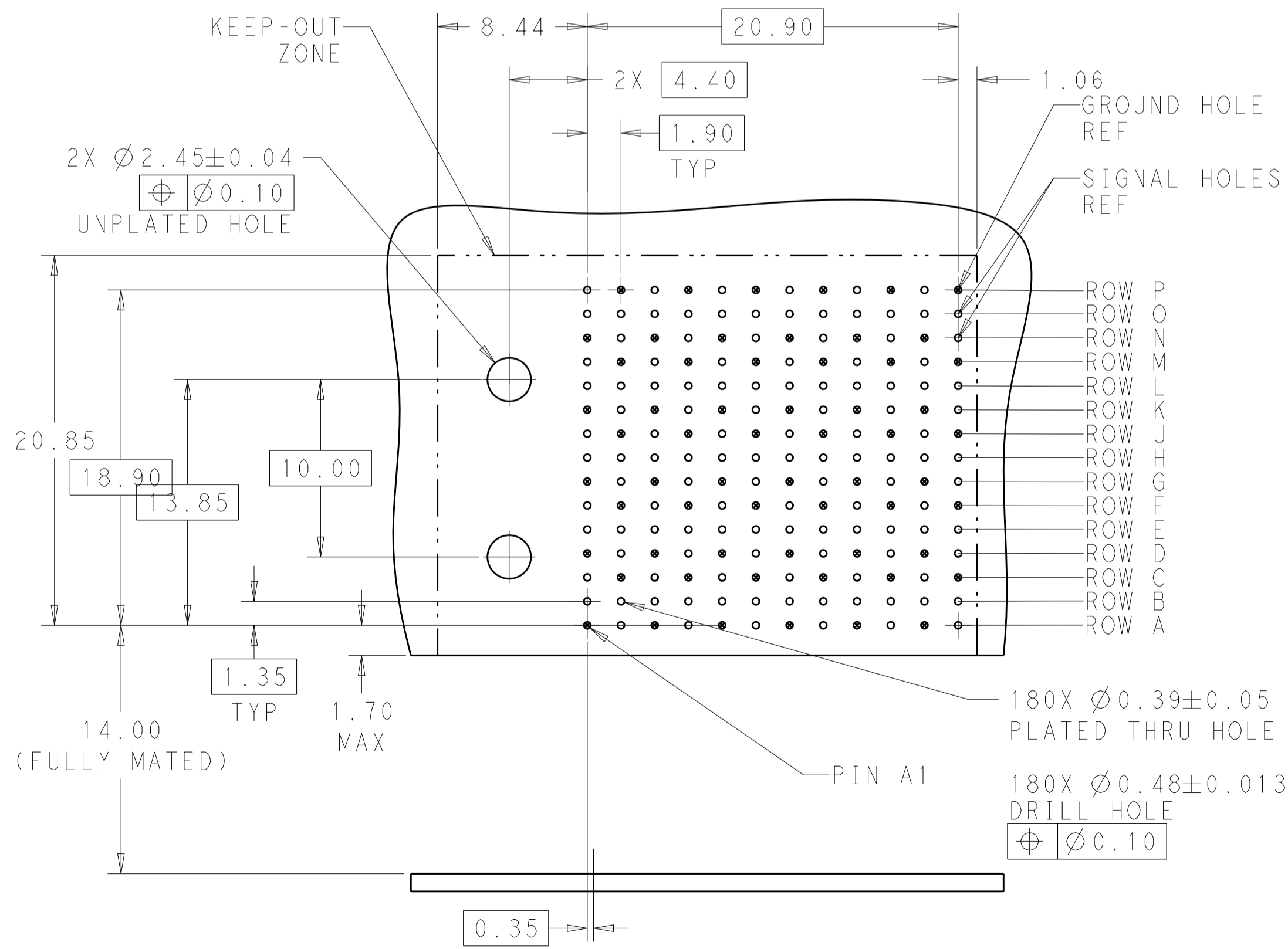
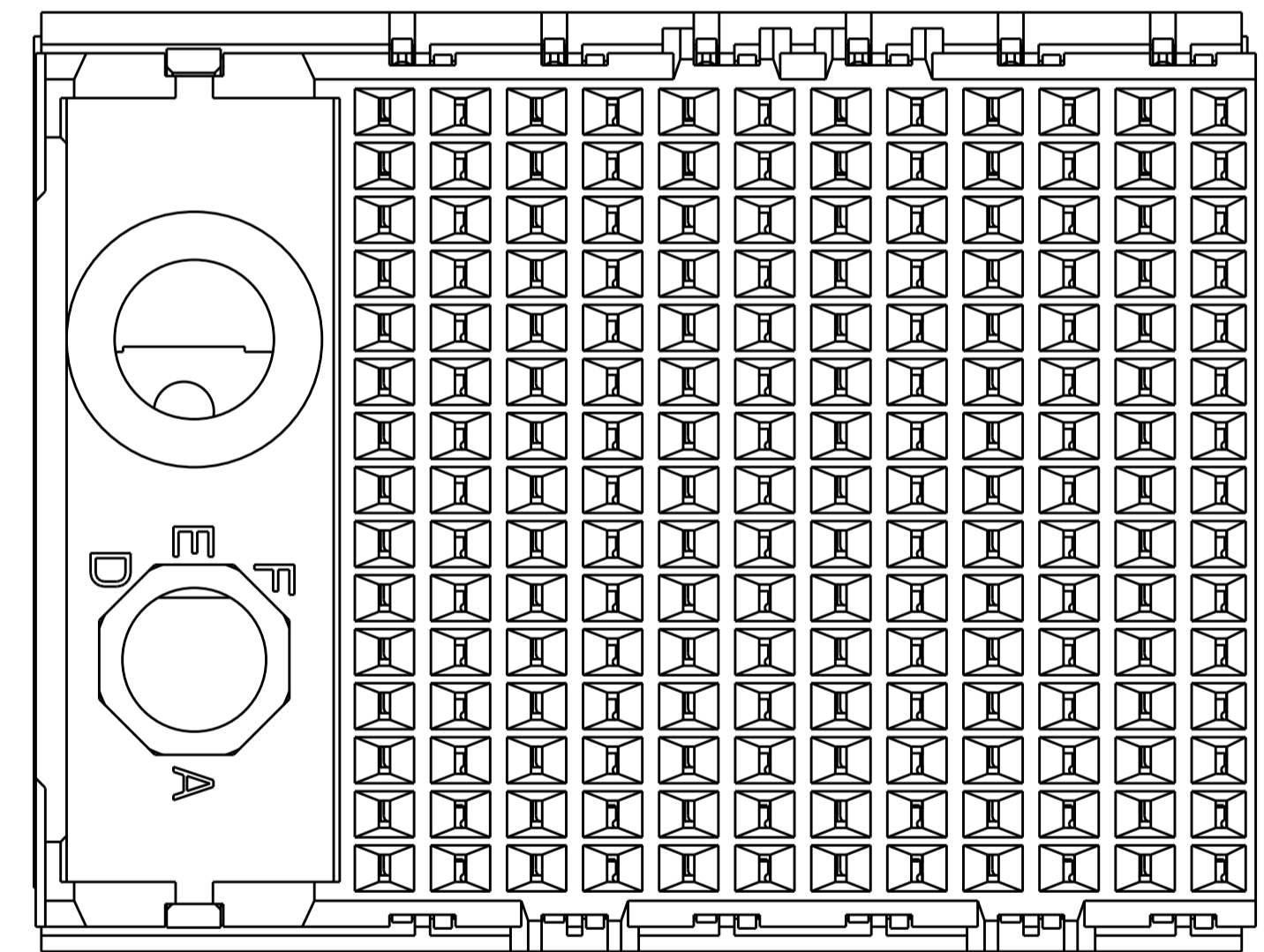


- ⚠ MATERIAL:
HOUSING: LCP, GLASS FILLED, UL94V-0.
TERMINALS: HIGH PERFORMANCE COPPER ALLOY.
- ⚠ FINISH:
30μ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN ON PCB TAILS, NICKEL OVERALL.
- 3. CONNECTORS SUPPLIED WITH MOUNTING SCREWS.



SCALE 4:1

REFER TO WWW.TE.COM FOR PRODUCT AVAILABILITY



KEY POSITION CHART	
	NONE
	A
	B
	C
	D
	E
	F
	G
	H

OFFSET BETWEEN BOARD AND BACKPLANE HOLE COLUMNS
RECOMMENDED PCB LAYOUT
MIN BOARD THICKNESS 1.0

KEY POSITION	FINISH	PART NUMBER
H	⚠	8-2110110-1
G	⚠	7-2110110-1
F	⚠	6-2110110-1
E	⚠	5-2110110-1
D	⚠	4-2110110-1
C	⚠	3-2110110-1
B	⚠	2-2110110-1
A	⚠	1-2110110-1
NONE	⚠	2110110-1

THIS DRAWING IS A CONTROLLED DOCUMENT. DWN 07JUL2011

TE Connectivity

IMPACT, 5 PAIR, DAUGHTERCARD
12 COLUMN, LEFT GUIDED, SIGNAL
MODULE, 0.39 EYELET

100779C=2110110

SCALE 6:1 SHEET 1 OF 1 REV B2